

TOUCH PANEL SPECIFICATIONS	Projected	Glass	3.5"
	Capacitive	Substrate	Diagonal
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Part Number	NVDS-TP1136DA035S-01		
Outline Dimensions of TP sensor	59.8(W) x 81.3(H) x 0.55(T) mm		
Overall Dimensions incl. cover lens	70.0(W) x 91.5(H) x 1.25(T) mm		
	(Can be changed)		
Active Area	53.56 (W) x 71.08(H) mm		
Input Method	Finger or Gloved Finger		
Number of simultaneous touches	one and gesture		
Min. spacing between two touches	15mm		
Positional Accuracy	± 2mm at 4 edges and ±1.5mm at center		
Touch System Resolution	<0.2mm		
Response Time / Speed	<10msec		
Minimum Touch Area	30mm ²		
Minimum Touch Pressure	0 N		
Optical Transmittance	>87%		
ITO resistivity	80 Ω/□		
Index matching	No (available on request)		
Anti-glare surface	No (available on request)		
Operating temperature	-20°C to +70°C, up to 90% RH non-condensing		
Storage temperature	-30°C to +80°C, up to 90% RH non-condensing		
Number of touches	>10 million over lifetime		
Surface Hardness	>6H		
FPC* attachment method	ACF bonding		
FPC pull-off strength	>50g/mm		
FPC bending radius	1mm		
Touch controller	FT6306		
Interface to Host	I2C		
Operating Voltage	3.3V		
Power consumption	Idle mode: <0.5mW, Active mode <50mW		

^{*} FPC shape customized



